Technical Document

Opto Specification

Opto/EC Group

GW5BNF15L00 LED Module

Product Specification June 2008

High-output 7-Watt LED Module (350 lm) featuring High Color Rendering and 5000°K color temperature



SPEC. No. DG-087007



ISSUE

Jun-27-08

ELECTRONIC COMPONENTS AND DEVICES GROUP

SHARP CORPORATION

SPECIFICATION

DEVICE SPECIFICATION FOR LIGHT EMITTING DIODE MODULE

MODEL No.

GW5BNF15L00

Specified for

Reference

CUSTOMERS' APPROVAL

Date

By

PRESENTED

Date

By

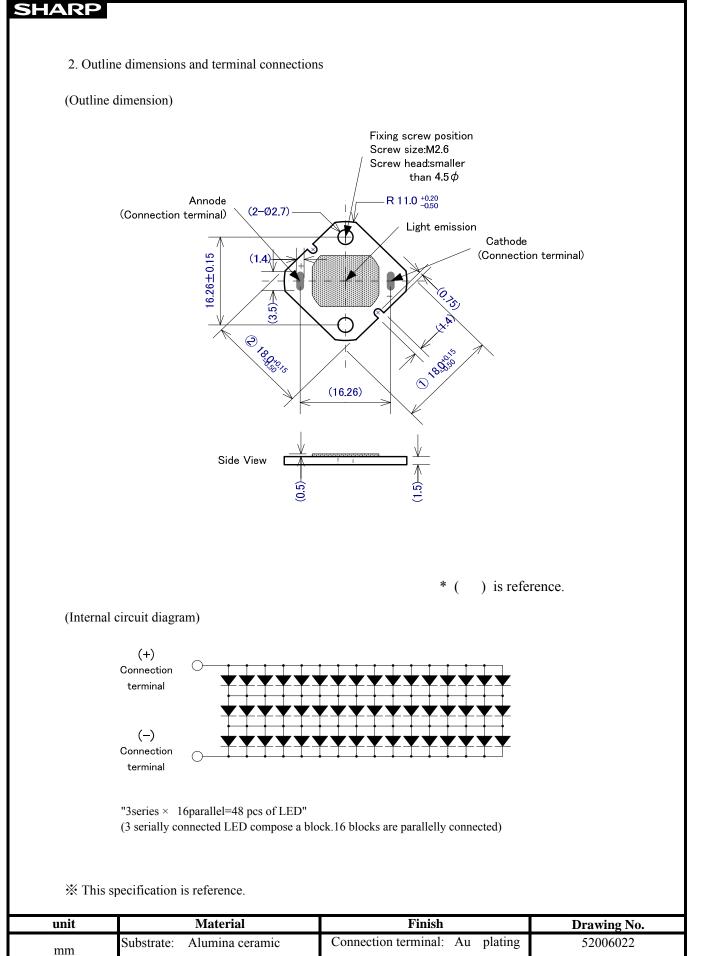
Y.Inada, Department General Manager A1249 Project Team ELECTRONIC COMPONENTS AND DEVICES GROUP SHARP CORPORATION

Jun-27-08

PRODUCT NAMELight Emitting Diode ModuleMODEL No.GW5BNF15L00

1. These specification sheets include materials protected under the copyright of Sharp Corporation ("Sharp"). Please do not reproduce or cause anyone to reproduce them without Sharp's consent. 2. When using this product, please observe the absolute maximum ratings and the instructions for use outlined in these specification sheets, as well as the precautions mentioned below. Sharp assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets, and the precautions mentioned below. (Precautions) (1) This products is designed for use in the following application areas; * OA equipment * Audio visual equipment * Home appliance * Telecommunication equipment (Terminal) * Measuring equipment * Tooling machines * Computers If the use of the product in the above application areas is for equipment listed in paragraphs (2) or (3), please be sure to observe the precautions given in those respective paragraphs. (2) Appropriate measures, such as fail-safe design and redundant design considering the safety design of the overall system and equipment, should be taken to ensure reliability and safety when this product is used for equipment which demands high reliability and safety in function and precision, such as ; * Transportation control and safety equipment (aircraft, train, automobile etc.) * Traffic signals * Gas leakage sensor breakers * Rescue and security equipment * Other safety equipment (3) Please do not use this product for equipment which require extremely high reliability and safety in function and precision, such as ; * Space equipment * Telecommunication equipment (for trunk lines) * Nuclear power control equipment * Medical equipment (4) Please contact and consult with a Sharp sales representative if there are any questions regarding interpretation of the above three paragraphs. 3. Manufacturing method or materials of this product which does not influence on its specifications are subject to change without notice. 4. Please contact and consult with a Sharp sales representative for any questions about this product.

	GW5BNF15L00
HARP	
<u>GW5BNF15L00</u>	Specification
1. Application	
This specification applies to the light emitting diode n	
[White (from InGaN Blue LED chip + Phosphor) LEI) module]
Main use : Illumination	
2. Outline dimensions and terminal connections	Refer to the attached sheet Page 3.
	-
3. Ratings and characteristics	Refer to the attached sheet Page 4. \sim 6.
3-1. Absolute maximum ratings	
3-2. Electro-optical characteristics	
3-3. Derating Curve3-4. Characteristics Diagram	
Characteristics Diagram	
4. Reliability	Refer to the attached sheet Page 7.
4-1. Test items and test conditions	
4-2. Failure judgment criteria	
5. Quality level	Refer to the attached sheet Page 8.
5-1. Inspection method	
5-2. Description of inspection and criteria	
6. Supplement	Refer to the attached sheet Page 9. ~ 10 .
6-1. Chromaticity coordinates	
6-2. Packing	
6-3. Label	
6-4.Indication to the product	
7. Precautions for use	Refer to the attached sheet Page 11. \sim 12.
* This specification is reference.	
~ 1115 Specification is reference.	



3. Ratings and characteristics

3-1. Absolute maximum ratings

Item	Symbol	Rating	Unit
Power dissipation *1	Р	8.0	W
Forward current *1	$I_{\rm F}$	700	mA
Reverse Voltage	V _R	-15	V
Operating temperature *2	Topr	-30~+90	°C
Storage temperature	Tstg	-40∼+100°C	°C

*1 Power dissipation and forward current are the value when the module temperature is set lower than the rating by using an adequate heat sink.

*2 Operating temperature is fixed to the temperature of module's external part.

(Not an ambient temperature)

The derating curve in the next page is applied to the operating current.

3-2. Electro-optical characteristics

					Tc	=25 °C
Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Forward voltage	V _F	IF=640mA	8.5	(10.2)	11.5	V
Luminous Flux	φ	IF=640mA	260	(350)	-	lm
*3						
Chromaticity	х	IF=640mA	-	0.345	-	
*4	У		-	0.351	-	
	Tc		(4700)	5000	(5300)	K

* () is reference.

.....

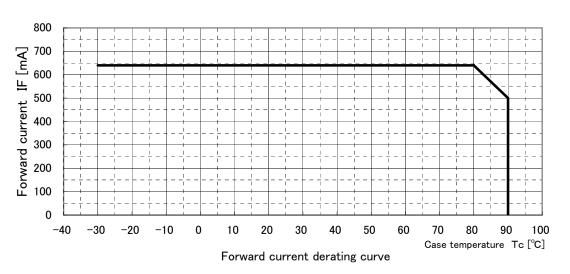
(*3) Monitored by 8 inch integrating sphere of Sharp Standards. (After 20 ms drive) (Tolerance: ±15%)

(*4) Monitored by 8 inch integrating sphere of Sharp Standards Measured by Otsuka electronics MODEL LE-3400 (After 20 ms drive) (Tolerance: x, y: ±0.02)



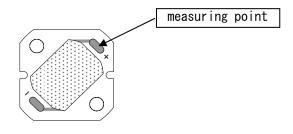


3-3. Derating Curve

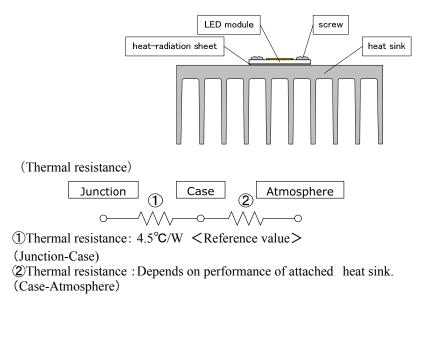


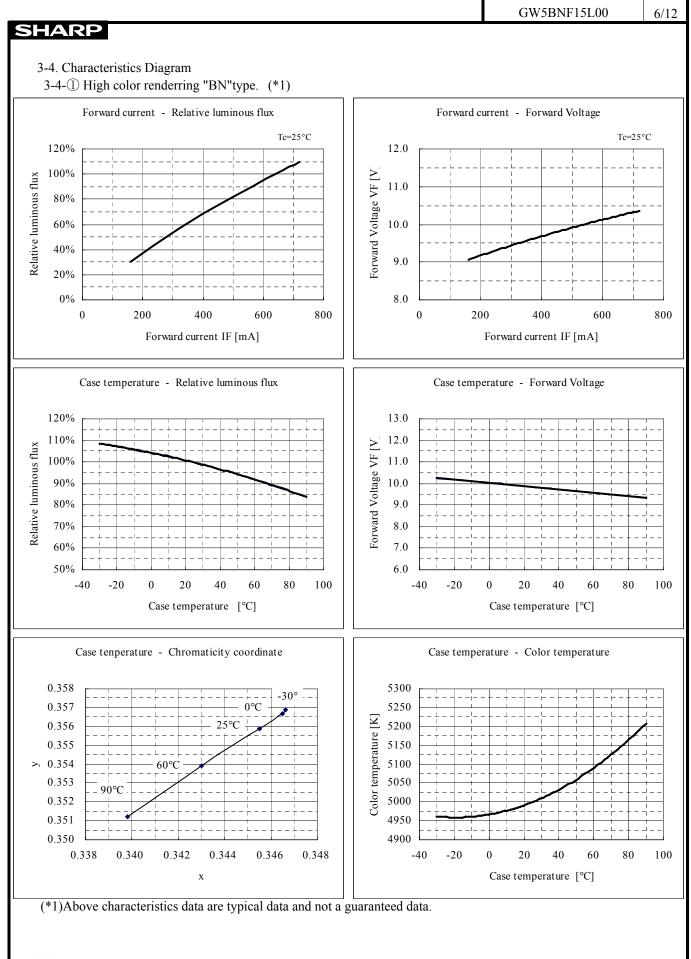
*To keep case temperature lower than the rating, enough heat-radiation performance needs to be secured by using an adequate heat sink. To secure long-term life,use it by the current equal to or less than 640mA.

(Measuring point for case temperature)



(Example of heat sink attachment)





4. Reliability

The reliability of products shall be satisfied with items listed below.

4-]	4-1. Test items and test conditions Co				Confidence level: 90%		
No.	Test items	Test conditions	Samples	Defective	LTPD		
			n	С	(%)		
1	Temperature	-40 °C(30 min)~+100 °C(30 min), 30 times					
	cycle		11	0	20		
2	High temp and high	Ta*=+60°C, RH=90%, t=1,000h					
	humidity storage		11	0	20		
3	High temperature	$Ta^{*}=+100^{\circ}C, t=1,000h$					
	storage		11	0	20		
4	Low temperature	Ta*= -40 °C, t=1000h					
	storage		11	0	20		
5	Operating test	Tc=60 °C, IF=640mA, t=1,000h					
			11	0	20		
6	Mechanical shock	$15,000 \text{ m/s}^2, 0.5 \text{ ms}$					
	test	$\pm X \cdot \pm Y \cdot \pm Z$ direction, 3 times	5	0	50		
7	Variable frequency	200 m/s^2 , $100 \sim 2,000 \sim 100 \text{ Hz}$ / sweep for 4 min.					
	vibration	$X \cdot Y \cdot Z$ direction, 4 times	5	0	50		

4-2. Failure judgment criteria

No.	Parameter	Symbol	Failure judgment criteria (*2)
1	Forward voltage	V _F	$V_F > U.S.L \times 1.1$
2	Luminous flux	Φ	$\Phi \le$ Initial value × 0.5, $\Phi \ge$ Initial value × 2.0

- 5. Incoming inspection
 - 5-1. Inspection method

A single sampling plan, normal inspection S-4 based on ISO 2859-1 shall be adopted.

5-2. Description of inspection and criteria

No.	Inspection items	Criteria	Defect	AQL
1	Emission	No emission	Major defect	0.1%
2		Not conforming to the specification (Forward voltage, Luminous flux and Chromaticity)		
3	Outline dimensions	Not conforming to the specification (Outline dimensions of \mathbb{D} , \mathbb{Q} in page3)	Minor defect	0.4%
4	Appearance	Nonconformity observed in product appearance is determined as good product except that electro-optical characteristics is affected by.	dereet	

*Products with removable foreign material attached on is not determined to be defective.

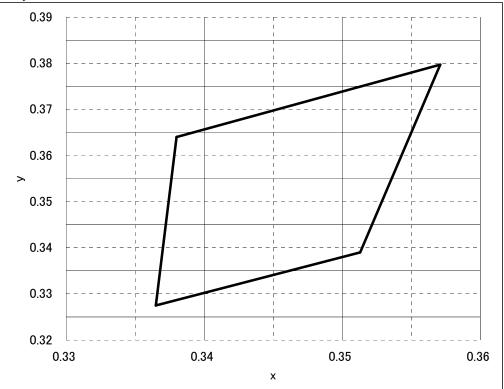
6. Supplement

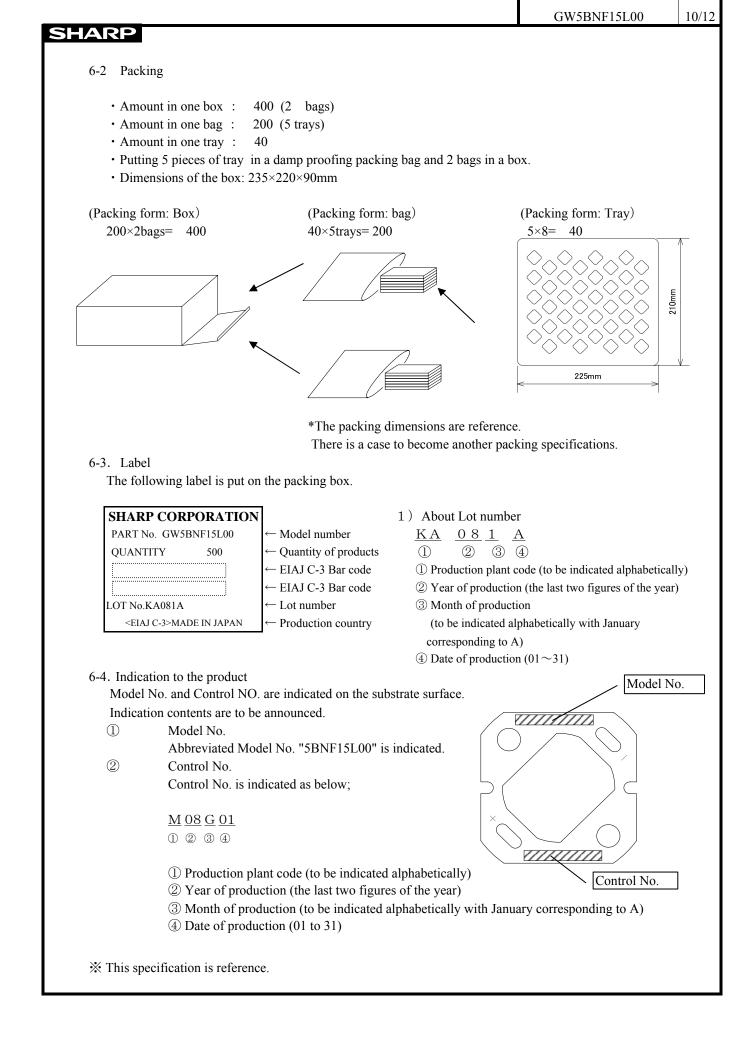
6-1 Chromaticity coordinates

(Chromaticity table)

BN:High color	Х	0.338	0.337	0.351	0.357
rendering 5000K	у	0.364	0.328	0.339	0.380

(Chromaticity coordinates)





SFARP

7. Precautions

① Storage conditions

Please follow the conditions below.

- ·Before opened: Temperature 5 \sim 30°C, humidity less than 60%RH
- •After opened : Temperature 5 \sim 30°C, humidity less than 60%RH (Please apply soldering within 1 week.)
- •Avoid exposing to air with corrosive gas.
- If exposed, electrode surface would be damaged, which may affect soldering.
- 2 Usage conditions

The products are not designed for the use under any of the following conditions.

Please confirm their performance and reliability well enough if you use under any of the following conditions;

- $\boldsymbol{\cdot}$ In a place with a lot of moisture, dew condensation, briny air, and corrosive gas
- (Cl, H_2S , NH_3 , SO_2 , NO_X , etc.).
- •Under the direct sunlight, outdoor exposure, and in a dusty place.
- $\boldsymbol{\cdot}$ In water, oil, medical fluid, and organic solvent.
- 3 Heat radiation

If the forward current(IF) is applied to single-state module at 360mA, there is a risk of damaging module or emitting smoke.

Equip with specified heat radiator, and avoid heat stuffed inside the module.

Applying thermal conductive sheet or grease between module and heat radiator enables heat to radiate effectively.

4 Installation

Material of board is alumina ceramic. If installed inappropriately, trouble of no radiation may occur due to board crack. Please take particular notice of install method.

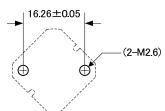
Further information on installation, refer to the following cautions.

- Apply ether screws or adhesives, or both of them when installed to heat radiator.
 - In case of applying adhesive only, check the effectiveness before fixing.

In case of screw, apply thread locker in order to prevent loosening.

If LED comes off from the heat radiator, unusual temperature rise entails hazardous phenomena including device deterioration, coming off of solder at leads, and emitting smoke.

• Refer to recommended dimensions when installing with screws.



• Screw torque: Within 0.2Nm

If it is inefficient to tighten screws, apply locker to prevent loosening.

- It is recommended to apply screws which use low corrosive materials such as Stainless steel. Avoid applying flat-head screws, which cause board crack due to applying stress to screw holes.
- Avoid convexly uneven boards. Those convex boards are subject to crack when tightening screws.
- It is recommended to apply thermal conductive sheet or grease with adhesiveness and heat radiatingadhesives, because of thermal and mechanical combination between module and heat radiator. However, depending on their thickness, board crack may be entailed by warped board, which is caused when tightening screws. So please check your actual conditions carefully as for the screw torque.

- ⑤ Module surface strength Module surface is subject to mechanical stress. Applying stress to surface of modules results in damage on resin, and inside-failure.
- 6 Connecting method

In case of solder connecting method, apply solder to the leads

by soldering iron with thermo controller (tip temperature 380°C), within 10seconds per one place.

Put the board on materials whose conductivity is poor enough not to radiate heat of soldering.

Avoid touching yellow phosphor with soldering iron.

This product is not designed for reflow and flow soldering.

⑦ Static electricity

This product is subject to static electricity, so take measures to cope with it.

Install circuit protection device to drive circuit, if necessary.

⑧ Drive method

Module is composed of LEDs connected in both series and parallel. Constant voltage power supply runs off more than specified current amount due to lowered VF caused by temperature rise.

Constant current power supply is recommended to drive.

Any reverse voltage cannot be applied to LEDs when they are in operation or not.

Design a circuit so that any flow of reverse or forward voltage can not be applied to LEDs when they are out of operation.

③ Cleaning

Avoid cleaning, since silicone resin is eroded by it.

10 Color-tone variation

Chromaticity of this product is monitored by integrating sphere right after the operation.

Chromaticity varies depending on measuring method, light spread condition, or ambient temperature.

Please verify your actual conditions before use.

1 Safety

Looking directly at LEDs for a long time may result in hurt your eyes.

In case that excess current(over ratings) are supplied to the device, hazardous phenomena including abnormal heat generation, emitting smoke, or catching fire can be caused.

Take appropriate measures to excess current and voltage.

In case of solder connecting method, there is a possibility of fatigue failure by heat.

Please fix the leads in such case to protect from short circuit or leakage of electricity caused by contact. Please confirm the safety standards or regulations of application devices.

Opto Specification

Opto/EC Group

SHARP®

NORTH AMERICA

Sharp Microelectronics of the Americas 5700 NW Pacific Rim Blvd. Camas, WA 98607, U.S.A. Phone: (1) 360-834-2500 Fax: (1) 360-834-8903 www.sharpsma.com

TAIWAN

Sharp Electronic Components (Taiwan) Corporation 8F-A, No. 16, Sec. 4, Nanking E. Rd. Taipei, Taiwan, Republic of China Phone: (886) 2-2577-7341 Fax: (886) 2-2577-7326/2-2577-7328

CHINA

Sharp Microelectronics of China (Shanghai) Co., Ltd. 28 Xin Jin Qiao Road King Tower 16F Pudong Shanghai, 201206 P.R. China Phone: (86) 21-5854-7710/21-5834-6056 Fax: (86) 21-5854-4340/21-5834-6057 Head Office: No. 360, Bashen Road, Xin Development Bldg. 22 Waigaoqiao Free Trade Zone Shanghai 200131 P.R. China Email: smc@china.global.sharp.co.jp

EUROPE

Sharp Microelectronics Europe Division of Sharp Electronics (Europe) GmbH Sonninstrasse 3 20097 Hamburg, Germany Phone: (49) 40-2376-2286 Fax: (49) 40-2376-2232 www.sharpsme.com

SINGAPORE

Sharp Electronics (Singapore) PTE., Ltd. 438A, Alexandra Road, #05-01/02 Alexandra Technopark, Singapore 119967 Phone: (65) 271-3566 Fax: (65) 271-3855

KOREA

Sharp Electronic Components (Korea) Corporation RM 501 Geosung B/D, 541 Dohwa-dong, Mapo-ku Seoul 121-701, Korea Phone: (82) 2-711-5813 ~ 8 Fax: (82) 2-711-5819

JAPAN

Sharp Corporation Electronic Components & Devices 22-22 Nagaike-cho, Abeno-Ku Osaka 545-8522, Japan Phone: (81) 6-6621-1221 Fax: (81) 6117-725300/6117-725301 www.sharp-world.com

HONG KONG

Sharp-Roxy (Hong Kong) Ltd. 3rd Business Division, 17/F, Admiralty Centre, Tower 1 18 Harcourt Road, Hong Kong Phone: (852) 28229311 Fax: (852) 28660779 www.sharp.com.hk Shenzhen Representative Office: Room 13B1, Tower C, Electronics Science & Technology Building Shen Nan Zhong Road Shenzhen, P.R. China Phone: (86) 755-3273731 Fax: (86) 755-3273735

SPECIFICATIONS ARE SUBJECT TO CHANGE WITHOUT NOTICE. Suggested applications (if any) are for standard use; See Important Restrictions for limitations on special applications. See Limited Warranty for SHARP's product warranty. The Limited Warranty is in lieu, and exclusive of, all other warranties, express or implied. ALL EXPRESS AND IMPLIED WARRANTIES, INCLUDING THE WARRANTIES OF MERCHANTABILITY, FITNESS FOR USE AND FITNESS FOR A PARTICULAR PURPOSE, ARE SPECIFICALLY EXCLUDED. In no event will SHARP be liable, or responsible in any way, for any incidental or consequential economic or property damage.

DG-087007

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for LED Lighting Modules category:

Click to view products by Sharp manufacturer:

Other Similar products are found below :

SFT-10-CG-R35-MPD PT-121-BL11-EPF CBT-120-B-C11-KK301 Z-G4-9WW SMJC2V08W2P4-GA PT-54-RAX-L35-MPH LMH02B-3000-27G9-00001TW CDM-14-3018-90-36-DW02 LMH02B-3000-40G9-00000TW LMH02B-3000-35G9-00000TW LMH02B-3000-30G9-00000TW LMH02B-2000-40G9-00001TW LMH02B-2000-35G9-00000TW LMH02B-2000-30G9-00000TW LMH02B-2000-27G9-00001TW LMH02B-1250-40G9-00001TW LMH02B-1250-35G9-00001TW LMH02B-1250-35G9-00000TW LMH02B-1250-30G9-00001TW LMH02B-1250-27G9-00001TW LMH02B-1250-27G9-00000TW CBM-120-UV-C31-FA365-21 SBR-90-R-R75-HN101 SBR-90-R-R75-HN100 SBR-70-G-R75-JK202 SBR-70-B-R75-KG300 PT-54-RAX-L35-MPN PT-54-RAX-L35-MPM PT-54-G-L31-MPJ PT-40-RAX-L55-MPL PT-40-RAX-L55-MPK PT-40-B-L51-EPJ PT-39-G-L51-CD100 PT-39-G-L21-MPF PT-121-RAX-L15-MPK PT-121-B-L11-EPG PT-120-RAX-L15-MPK PT-120-G-L11-MPK PT-120-B-L11-EPF CTM-9-6527-90-36-TW01 CTM-9-4018-90-36-TW01 CTM-22-6527-90-36-TW01 CTM-22-4018-90-36-TW01 CTM-18-6527-90-36-TW01 CTM-14-6527-90-36-TW01 CFT-90-WSS-X11-VA700 CFT-90-WSS-X11-VA700 CFT-90-WSS-X11-VA700